



**Product data sheet** 

### 1. General description

Ultrafast power diode in a 2-lead TO220F plastic package.

### 2. Features and benefits

- Low forward voltage drop
- Low leakage current
- Soft reverse recovery characteristics
- High thermal cycling performance

### 3. Applications

- Home appliance power supply
- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)

### 4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions		Va	lues		Unit
Absolute	maximum rating						
$V_{\text{RRM}}$	repetitive peak reverse voltage		600		V		
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T <sub>h</sub> ≤ 118 °C; Fig. 1; Fig. 2; Fig. 3	9		A		
I <sub>FRM</sub>	repetitive peak forward current	δ = 0.5 ; t <sub>p</sub> = 25 μs; T <sub>h</sub> ≤ 118 °C; square-wave pulse	18		A		
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	120 132		A		
		$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse			А		
Symbol	Parameter	Conditions	Min Typ Max		Unit		
Static ch	aracteristics						
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 8 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>		-	1.05	1.3	V
		I <sub>F</sub> = 8 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>		-	0.9	1.1	V
Dynamic	characteristics			,			
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$		-	40	75	ns

# **5. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode		
2	A	anode		K — A 001aaa020
mb	n.c.	mounting base; isolated		

# 6. Ordering information

Table 3. Ordering information								
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
BYV29X-600P	TO220F	BYV29X-600PQ	Tube	50	TO220FE-2L (E)	21-Dec-2020		
					SOD113A (A)	10-April-2014		

## 7. Marking

### Table 4. Marking codes

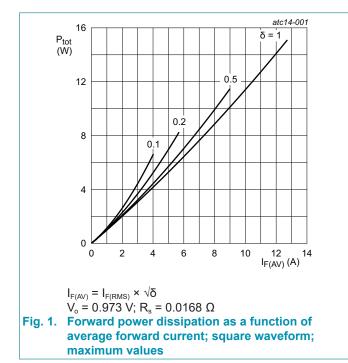
Type number	Marking codes				
	Assembly factory: E	Assembly factory: A			
BYV29X-600P	BYV29X 600P	BYV29X 600P			
	PJExxxx xx	PJAxxxx xx			

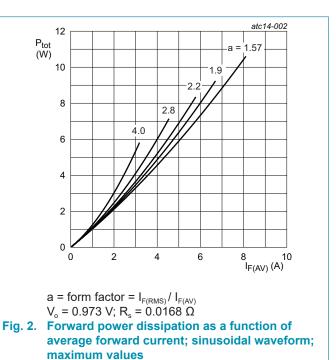
### 8. Limiting values

### Table 5. Limiting values

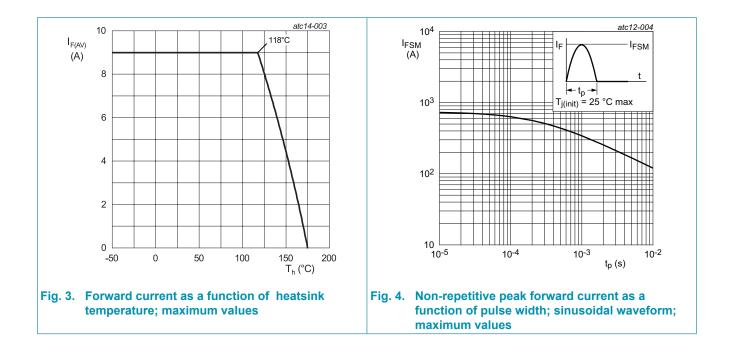
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
$V_{\text{RRM}}$	repetitive peak reverse voltage		600	V
$V_{\text{RWM}}$	crest working reverse voltage		600	V
V <sub>R</sub>	reverse voltage	DC	600	V
I <sub>F(AV)</sub>	average forward current	δ = 0.5 ; square-wave pulse; T <sub>h</sub> ≤ 118 °C; Fig. 1; Fig. 2; Fig. 3	9	A
I <sub>FRM</sub>	repetitive peak forward current	δ = 0.5; t <sub>p</sub> = 25 μs; T <sub>h</sub> ≤ 118 °C; square-wave pulse	18	A
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	120	A
		$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	132	A
T <sub>stg</sub>	storage temperature		-55 to 175	°C
Tj	junction temperature		175	°C



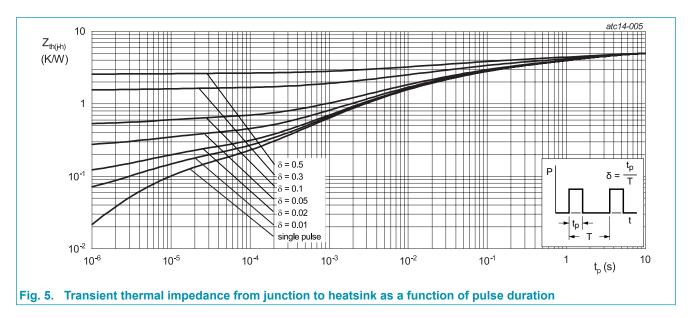


BYV29X-600P Ultrafast power diode



## 9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-h)}}$	thermal resistance from junction to heatsink	with heatsink compound; Fig 5	-	-	5	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	55	-	K/W

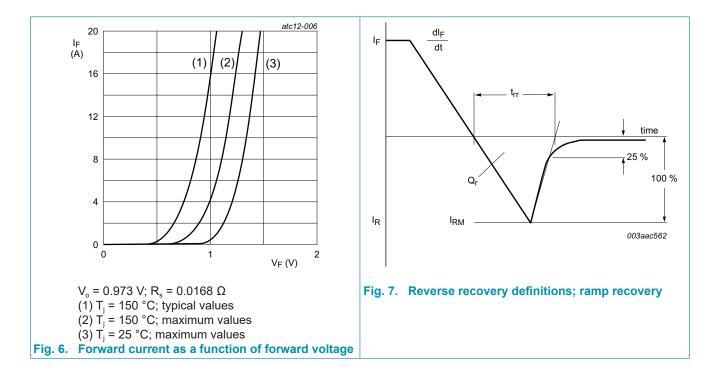


## 10. Isolation characteristics

Fable 7. Isolation characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{\text{isol}(\text{RMS})}$	RMS isolation voltage	50 Hz $\leq$ f $\leq$ 60 Hz; RH $\leq$ 65 %; from all pins to external heatsink; sinusoidal waveform; clean and dust free		-	-	2500	V
$C_{\text{isol}}$	isolation capacitance	f = 1 MHz; from cathode to external heatsink		-	10	-	pF

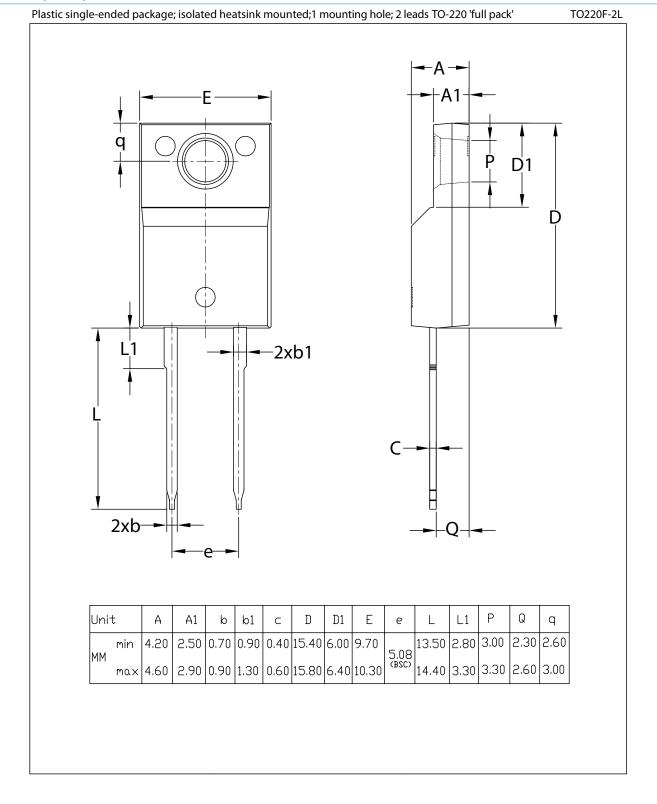
### **11. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics	· · · · ·	'			
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 8 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>	-	1.05	1.3	V
		I <sub>F</sub> = 8 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>	-	0.9	1.1	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 600 V; T <sub>j</sub> = 25 °C	-	-	10	μA
		V <sub>R</sub> = 600 V; T <sub>j</sub> = 150 °C	-	-	0.4	mA
Dynamic	characteristics	· · · ·	I			_
Q <sub>r</sub>	recovered charge	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	55	-	nC
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	40	75	ns
I <sub>RM</sub>	peak reverse recovery current	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	1.9	-	A
		I <sub>F</sub> = 1 A; V <sub>R</sub> = 30 V; dI <sub>F</sub> /dt = 100 A/μs; T <sub>i</sub> = 25 °C; <u>Fig. 7</u>	-	2.8	-	А

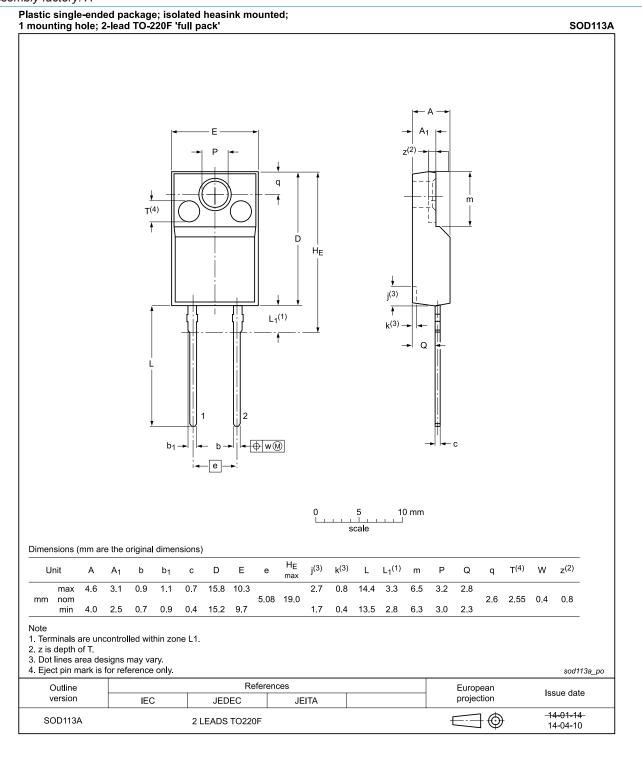


## **12. Package outline**

Assembly factory: E



### Assembly factory: A



## 13. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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